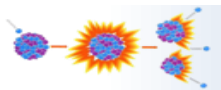


## Cu-based Nb<sub>3</sub>Sn QPR sample preparation via ETS bronze route

Ming Lu  
Institute of Modern Physics (IMP)  
Helmholtz-Zentrum Berlin (HZB)  
2024-09-17

- 1. Nb<sub>3</sub>Sn And QPR background**
- 2. Overall ETS bronze route progress**
- 3. Cu-based Nb<sub>3</sub>Sn QPR sample preparation**
- 4. Nb/Cu QPR sample baseline RF test**
- 5. Future work and Summary**



- Nb<sub>3</sub>Sn thin film superconducting cavity is the key technology for next-generation accelerator, and its engineering application will lead to a technological revolution in the field of SRF.



Courtesy of G. Ciovati, JLab

## Nb<sub>3</sub>Sn film on Cu cavity:

- Good thermal conductivity, better mechanical stability
- High performance@4.2 K, cooled by cryocooler

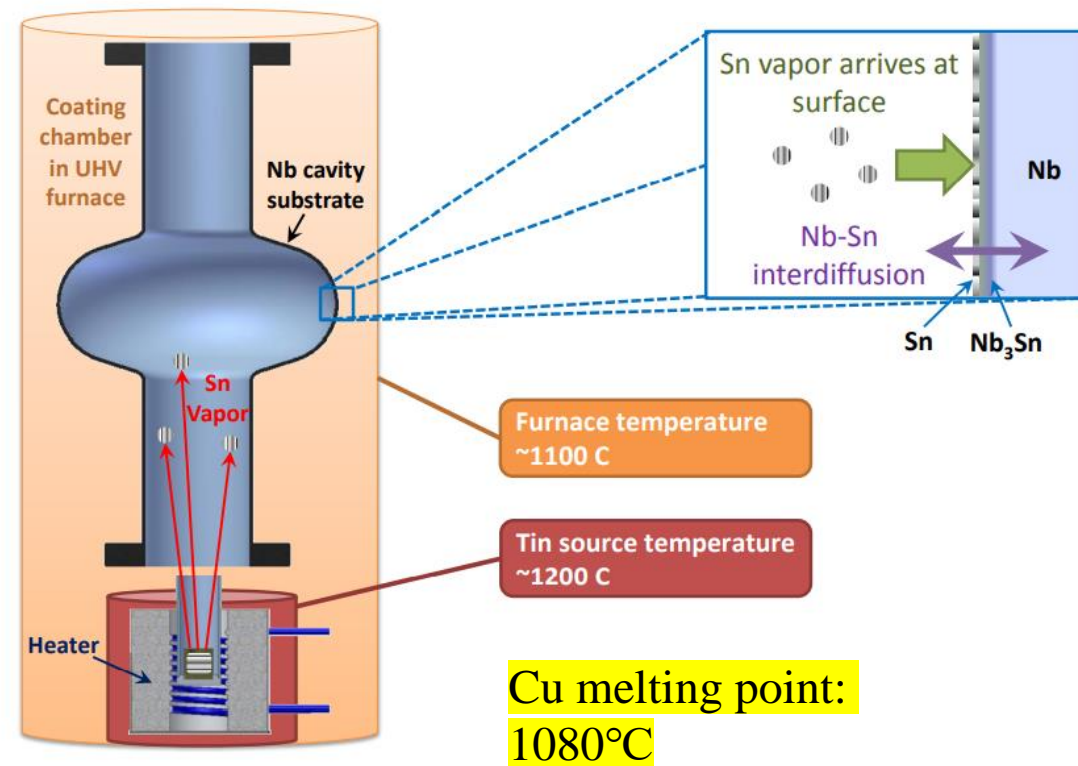
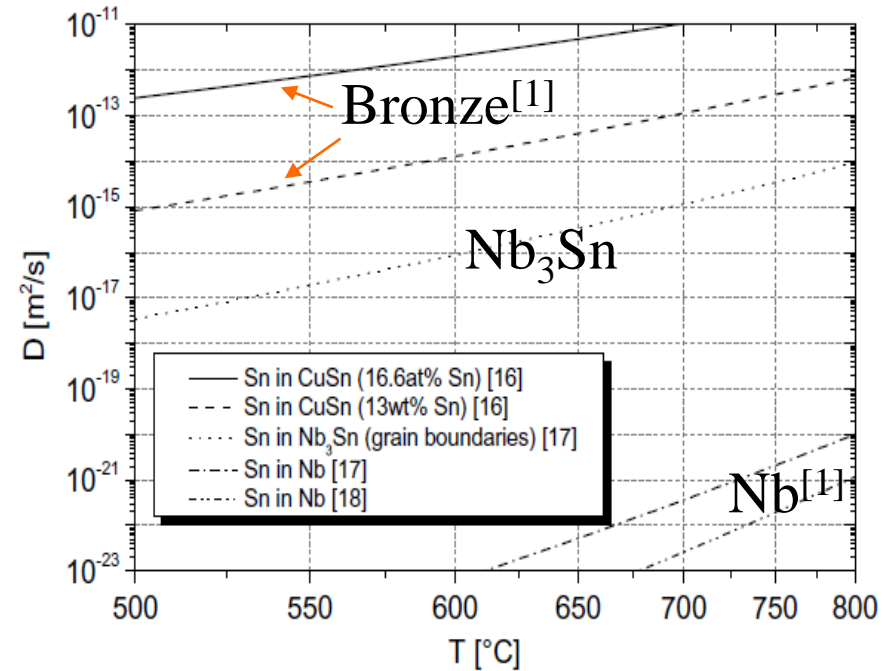
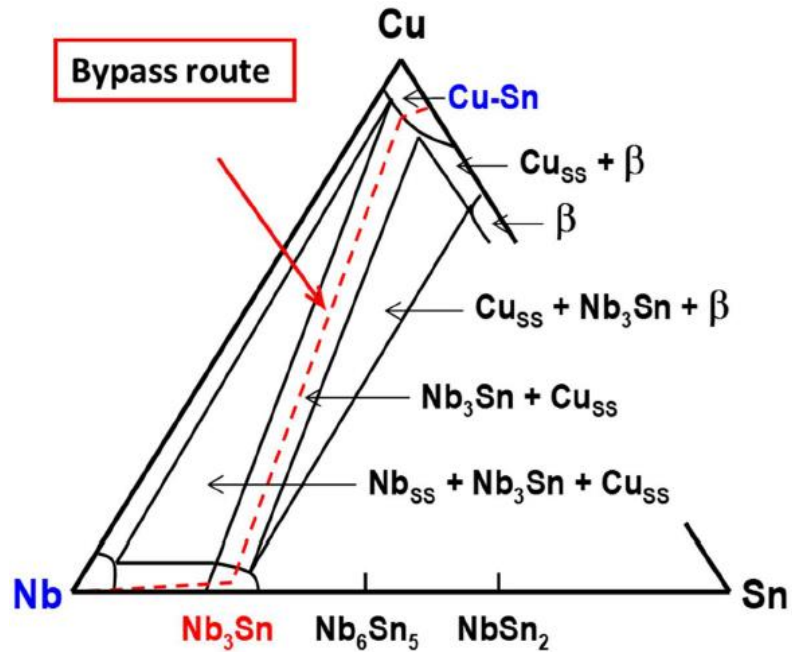


Diagram of the Tin Vapor Diffusion<sup>[1]</sup>

[1] Posen, Sam. "Understanding And Overcoming Limitation Mechanisms In Nb<sub>3</sub>Sn Superconducting Rf Cavities." (2015).

Phase diagram of Nb-Cu-Sn ternary system [2] at 700°C

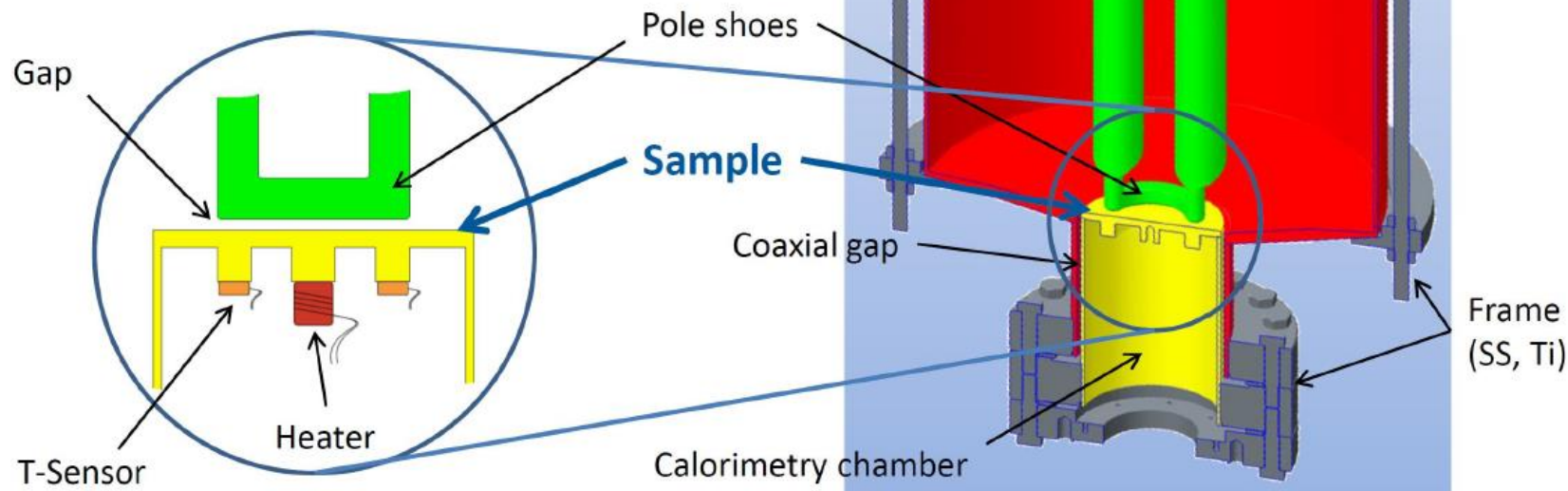


1. The copper can facilitate the interdiffusion between Nb and Sn by 7~10 magnitudes of orders.
2. The copper alloy will be excluded from the Nb<sub>3</sub>Sn phase by itself.

[1] H. Müller and T. Schneider, "Heat treatment of Nb<sub>3</sub>Sn conductors," Cryogenics, vol. 48, pp. 323-330, 2008/07/01/ 2008.

[2] L Mei, Z Du, C Guo, & C Li. (2009). Thermodynamic optimization of the cu-sn and cu-nb-sn systems. Journal of Alloys & Compounds, 477(1-2), 104-117.

- Quadrupole modes near 415, 845, 1286 MHz
- LHe bath at 1.8 K
- Sample thermally decoupled from cavity and LHe bath
- $B_{\text{Sample, max}} \sim 120 \text{ mT}$   
 $\sim 30 \text{ MV/m (TESLA)}$



## Surface resistance

- $R_S(\omega, B_{\text{RF}}, T)$
- $R_{\text{BCS}} \leftrightarrow R_{\text{res}}$
- High resolution  
 $R_S \approx 1 \text{ n}\Omega \leftrightarrow Q_0 > 10^{11}$
- Cooling conditions
- Trapped flux

## Penetration depth

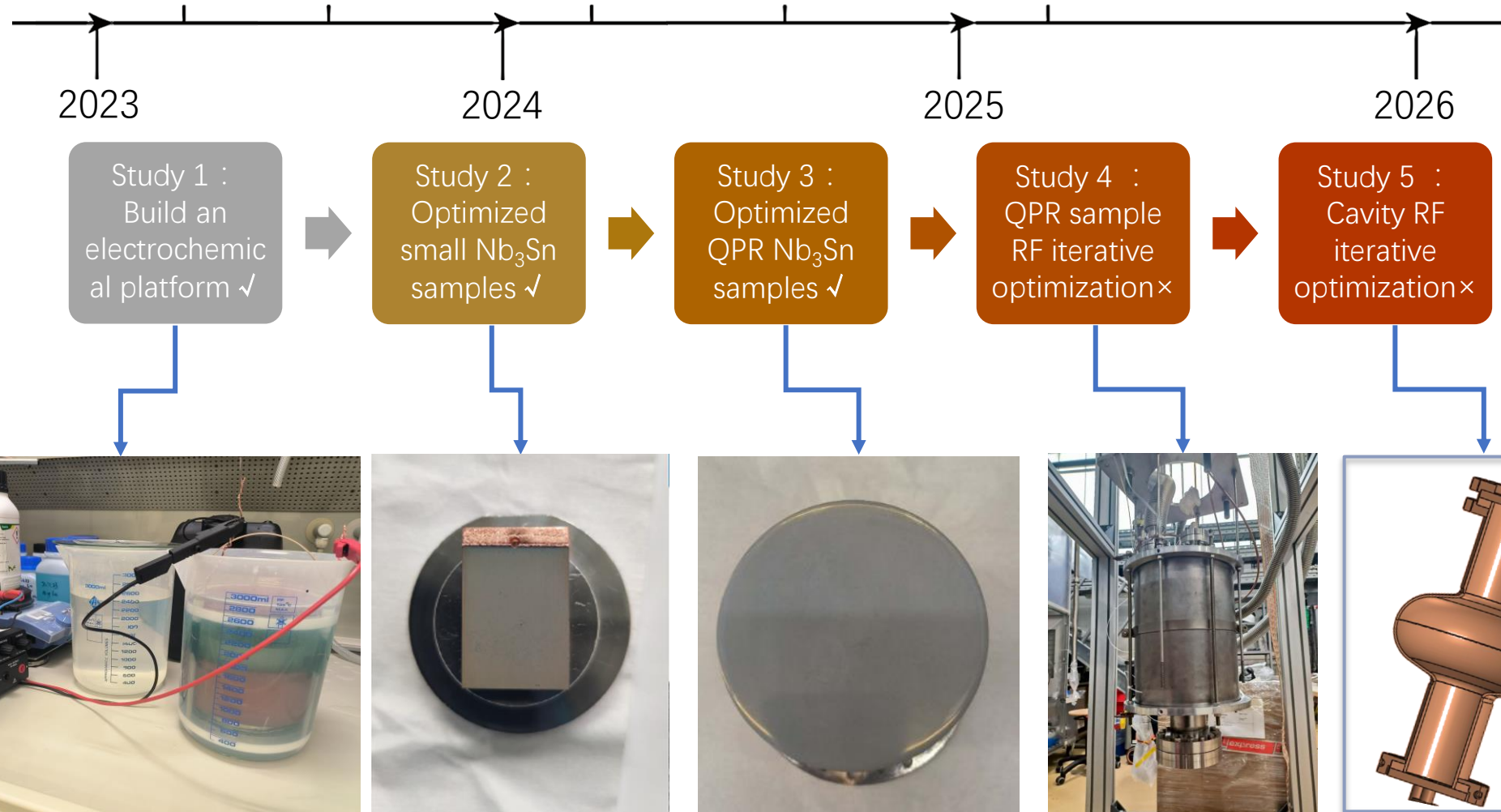
- Penetration depth  $\lambda(T)$
- Critical temperature  $T_c$

## RF quench field

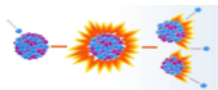
- $B_{\text{VP, RF}}(T, \omega)$
- $T_c$

*Oliver Kugeler*



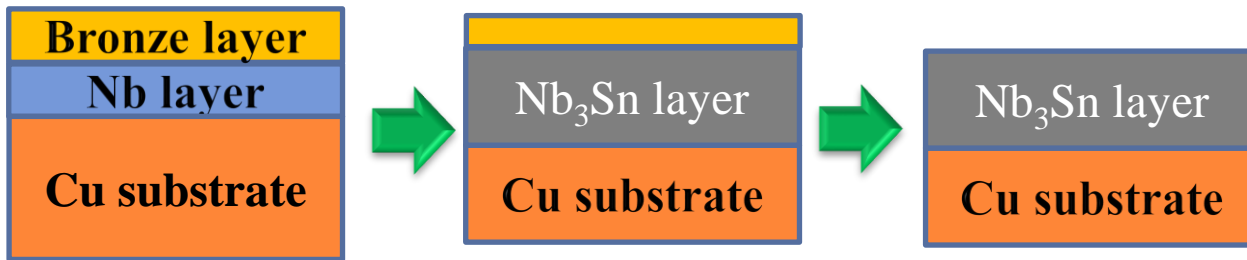


1. Nb<sub>3</sub>Sn background
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5. Future work and summary

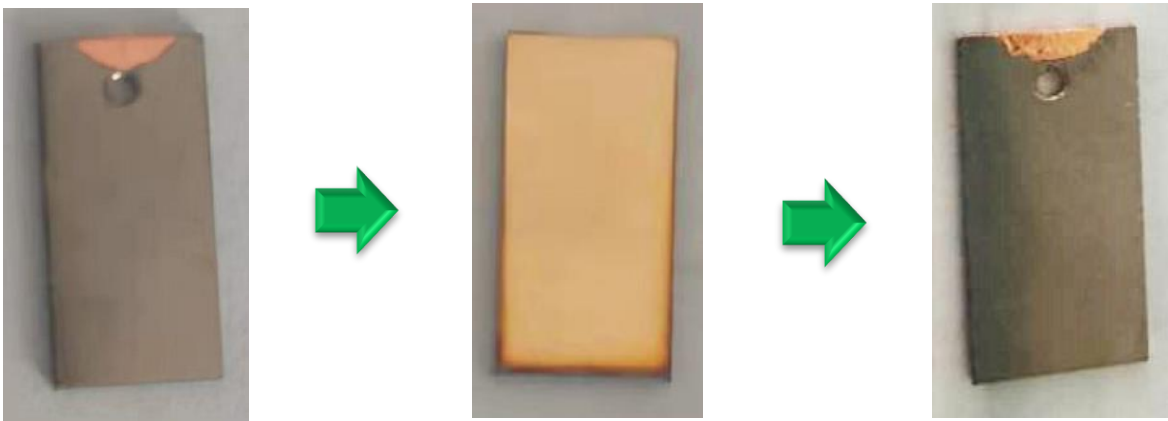


Nb<sub>3</sub>Sn/Cu sample preparations: **Electrochemical and Thermal Synthesis (ETS)** bronze route

- ✓ low cost, simple operation.
- ✓ suitable for complex cavity types, mass production.



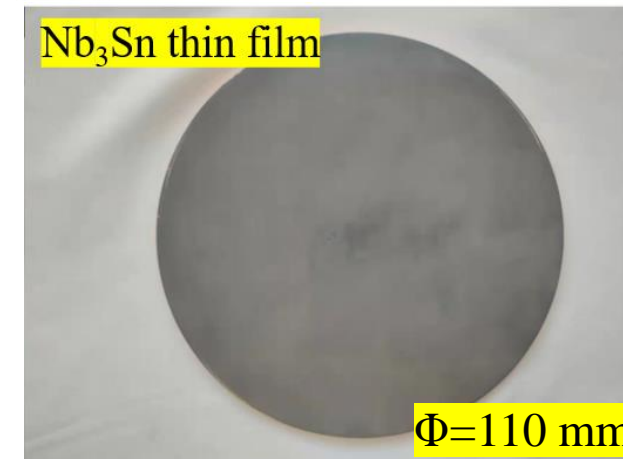
Nb layer: magnetron sputtering



Nb/Cu

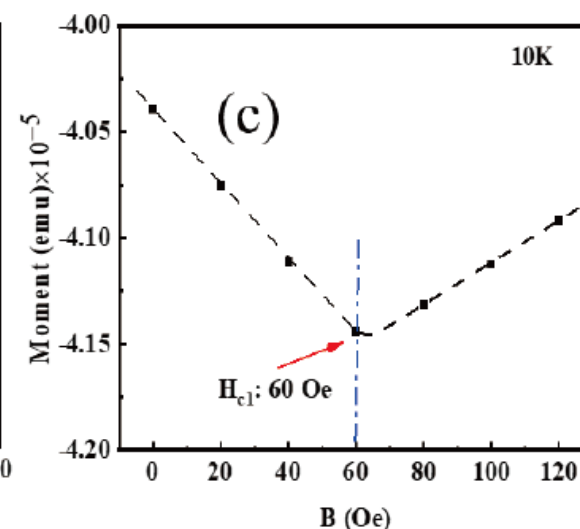
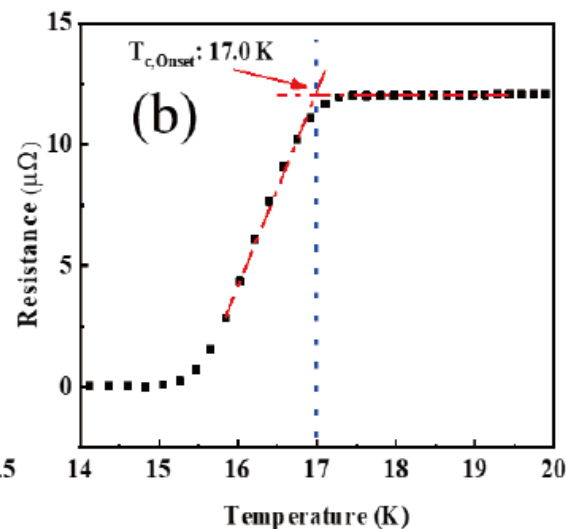
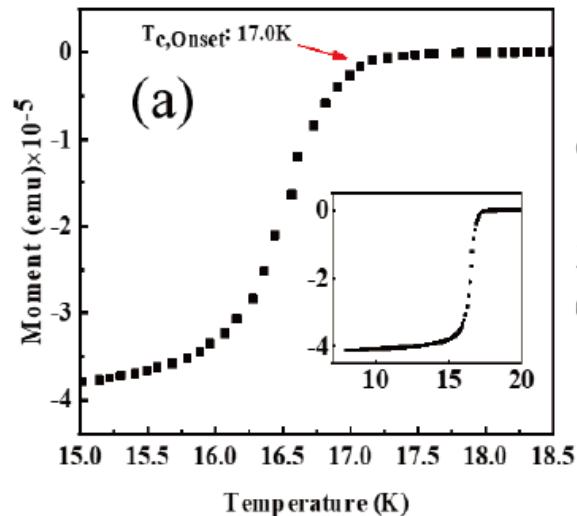
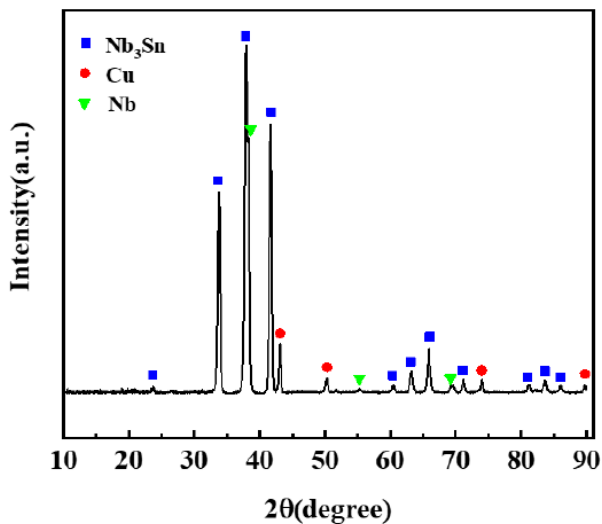
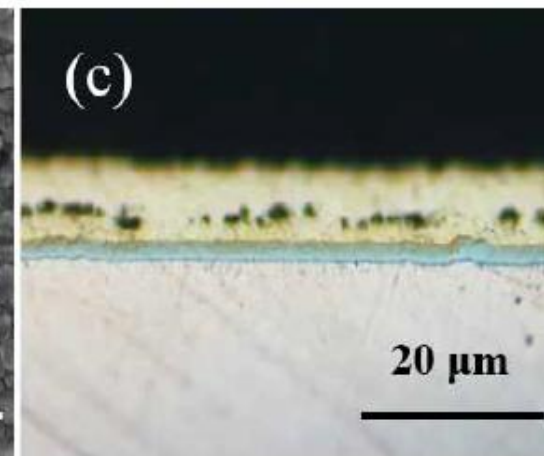
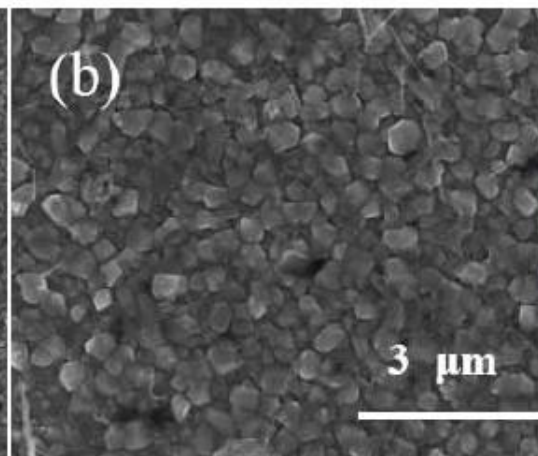
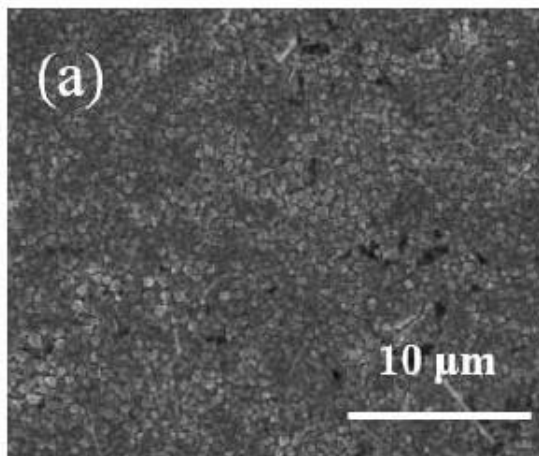
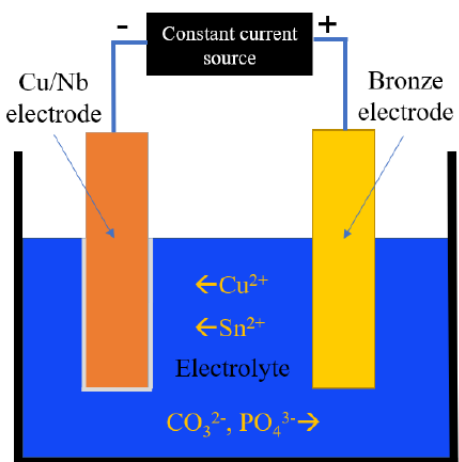
Bronze/Nb<sub>3</sub>Sn/Cu

Nb<sub>3</sub>Sn/Cu

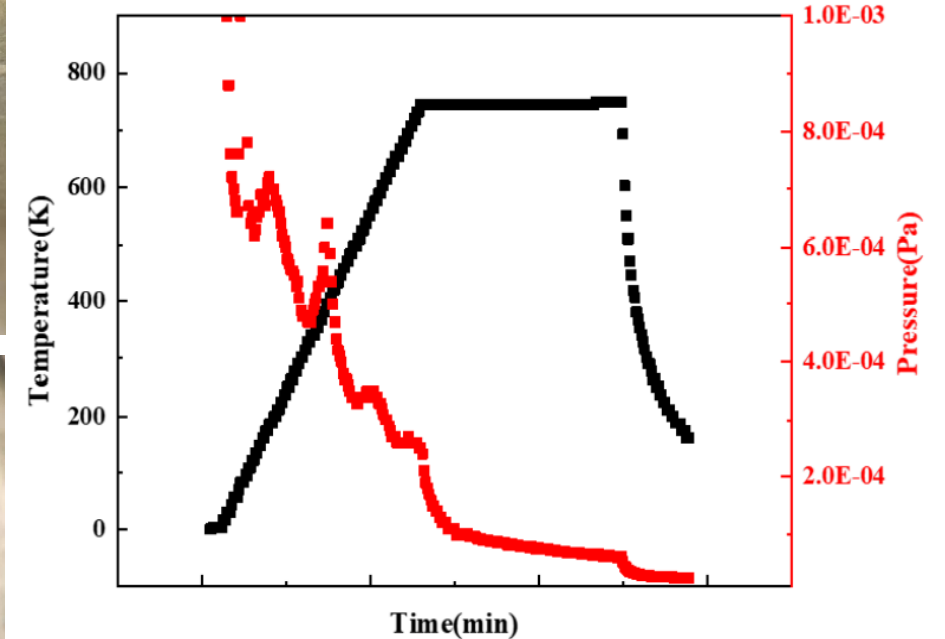
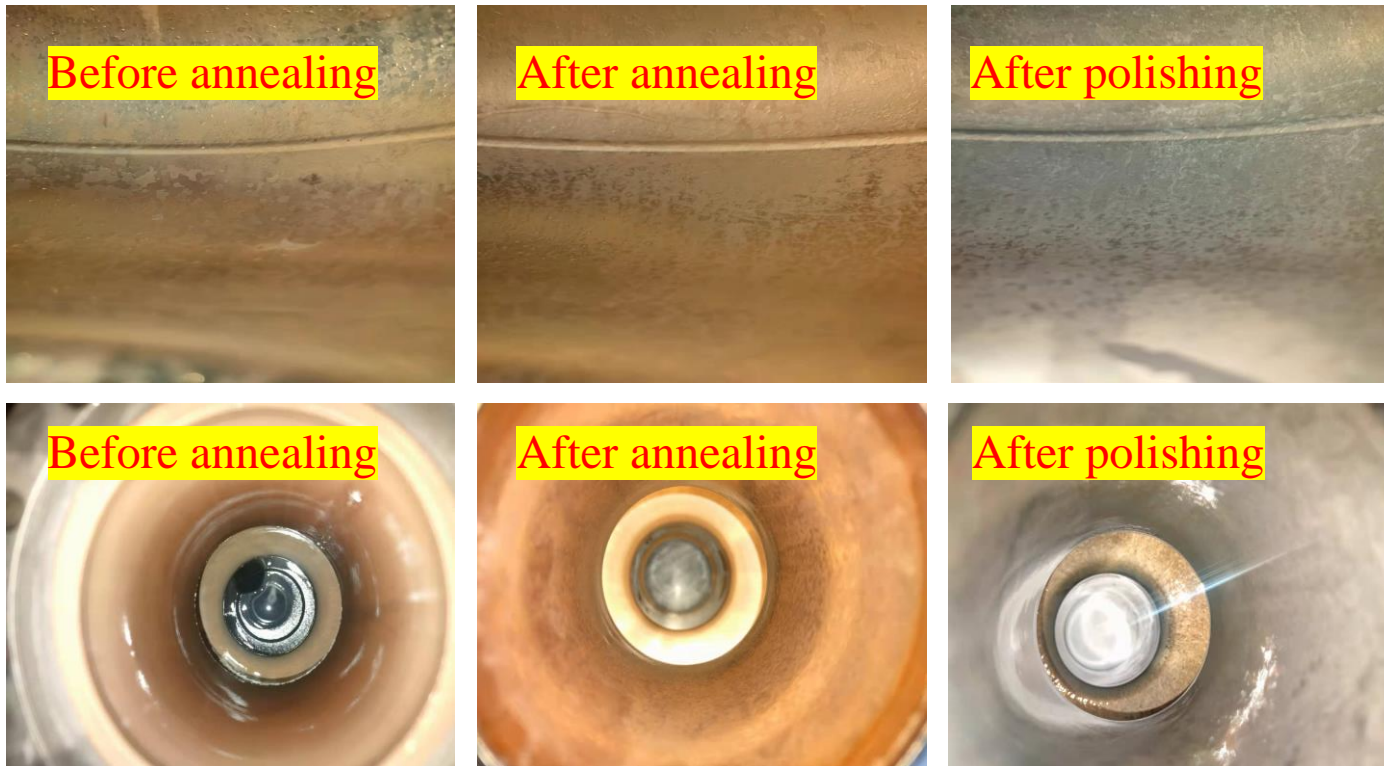




Nb<sub>3</sub>Sn/Cu sample properties:

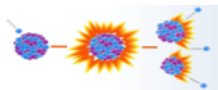


➤ The surface morphology of the different stages of the coating is shown in the figure below:

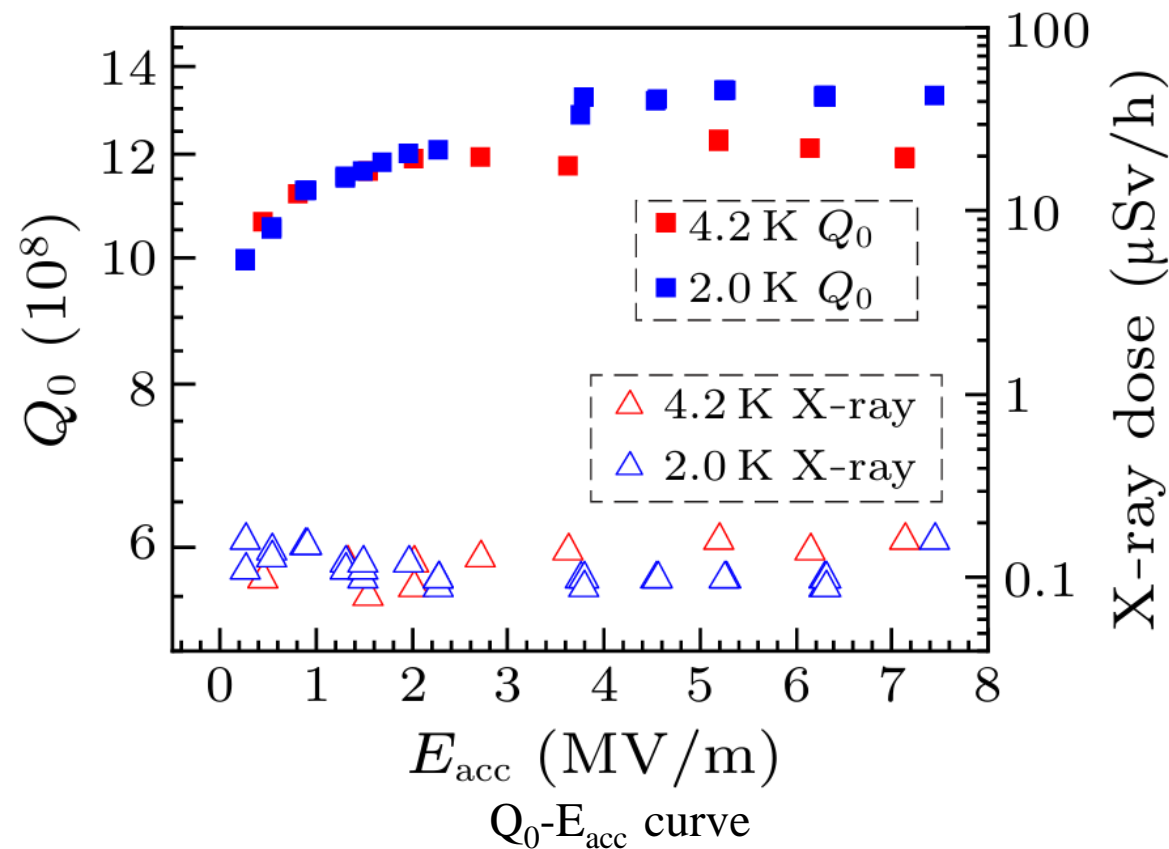
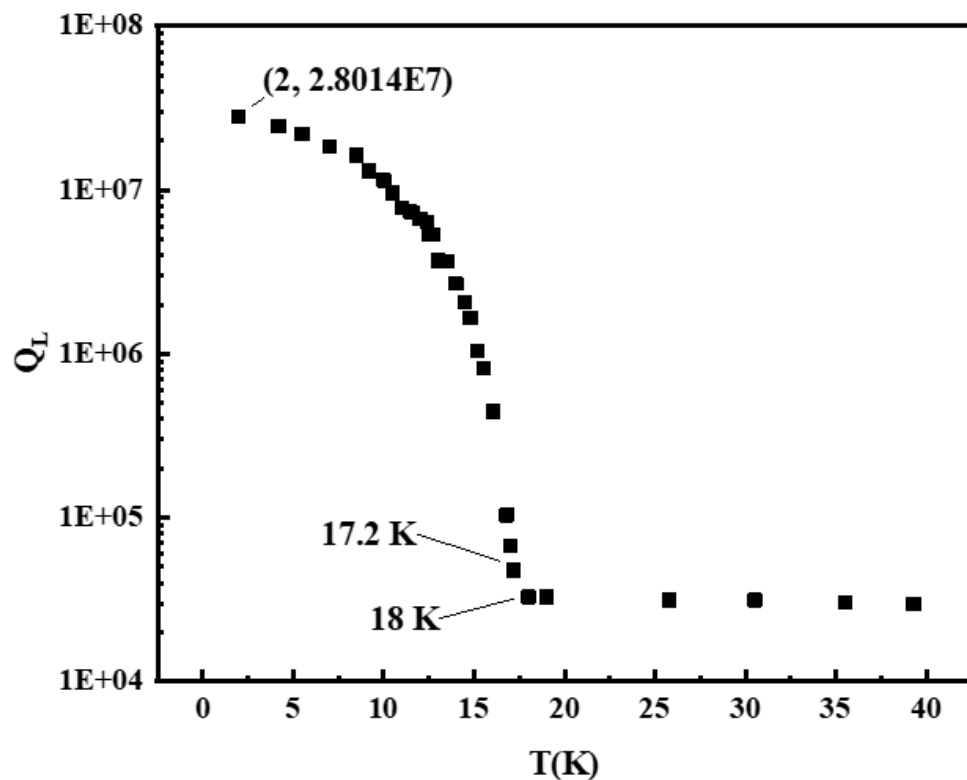


The relationship between annealing curve and air pressure with time.

➤ Morphology analysis: The film is complete and the film-base bond is good, but there are differences in the optical area, and niobium oxide is suspected.

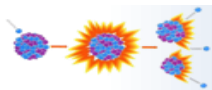


Low temperature vertical test:

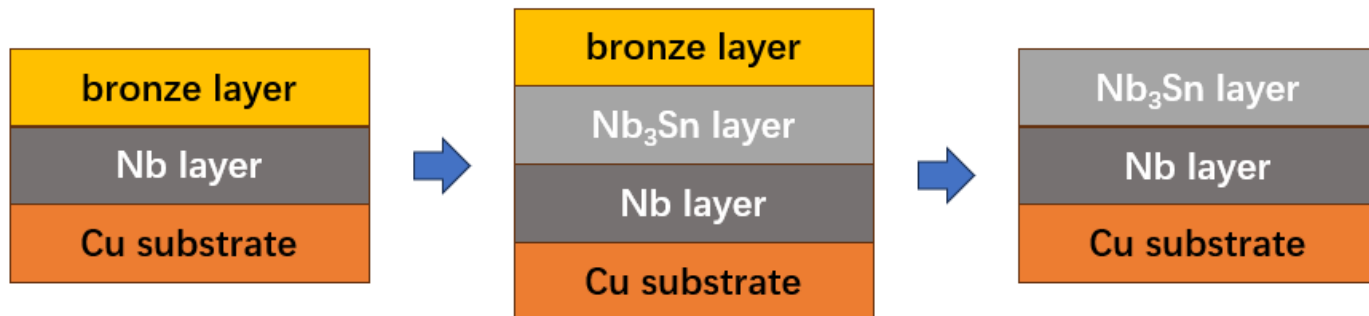


- The Q<sub>0</sub> of the thin-film cavity at 4.2 K is about 1.2E+9, which is better than that of the bulk niobium cavity under the same conditions.
- Without Q-Slope and X-ray, it is inferred that the reason for limiting E<sub>acc</sub> is thermal quench.

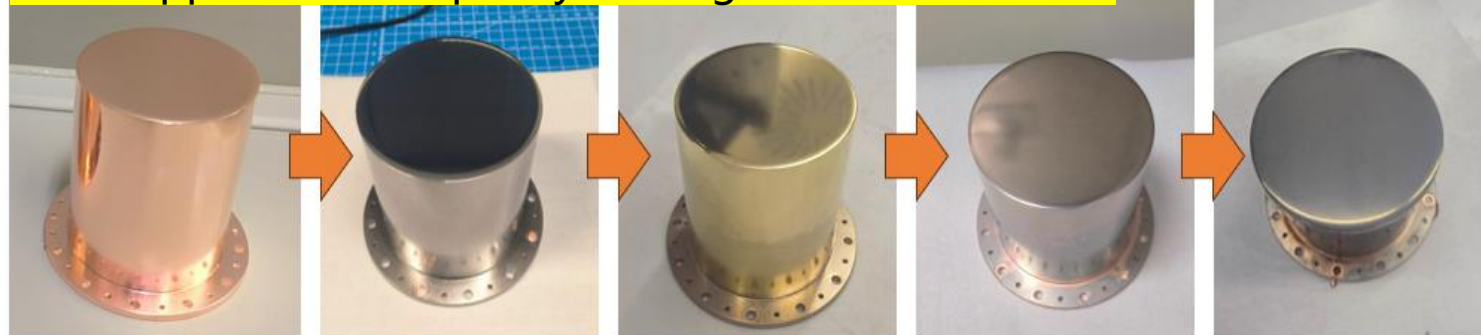
1. Nb<sub>3</sub>Sn and QPR background
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5. Future work and summary



The Nb<sub>3</sub>Sn/Cu QPR sample preparation process includes 6 steps:

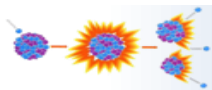
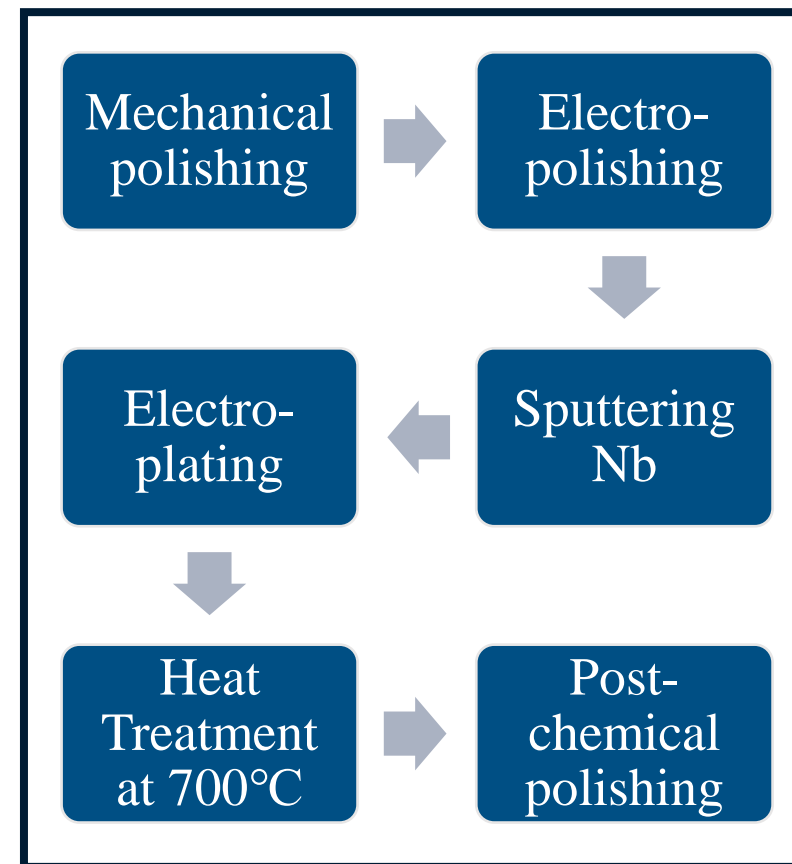


Bulk copper QPR sample by turning, no braze or weld.



Electropolishing    Sputtering Nb    Coating bronze    Annealing at 700°C    Polishing bronze

- A new Cu-based Nb<sub>3</sub>Sn QPR sample was successfully prepared.
- The Nb<sub>3</sub>Sn/Cu QPR sample RF properties will be tested at HZB soon.





Optimized cathode structure and key parameters:

- **New cathode structure:**

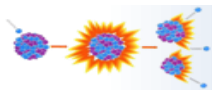
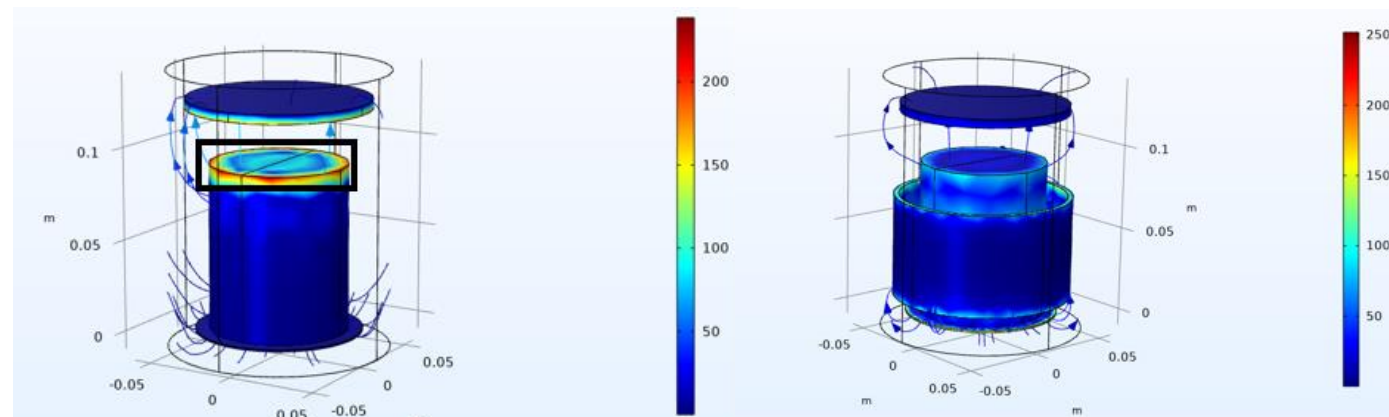
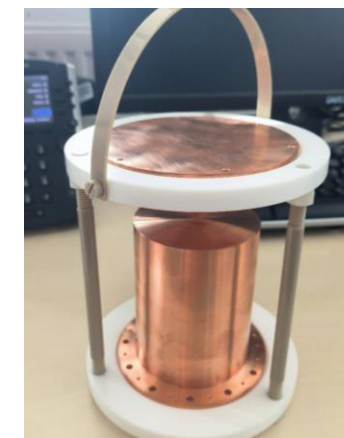
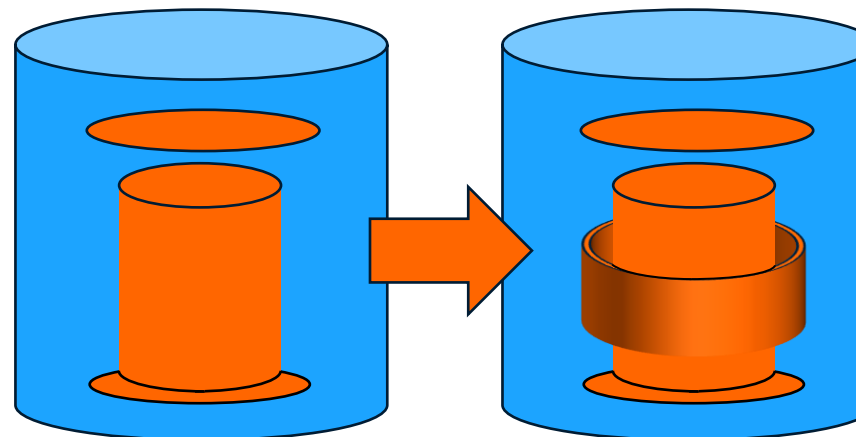
1. Only disk cathode before
2. Disk cathode and Round belt cathode

- **COMSOL simulation:**

The difference in current density is reduced from 16 times to 2-3 times

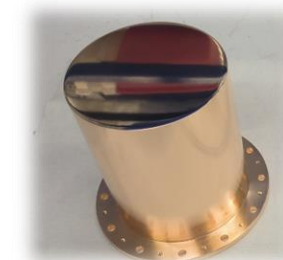
- **Parameters:**

1. CV mode: 2.1 V
2. Electrode distance: 20 mm
3. Temperature: 15 °C
4. Stirring speed: 100 rpm
5. Polishing time: 1 h (30  $\mu\text{m}$ )

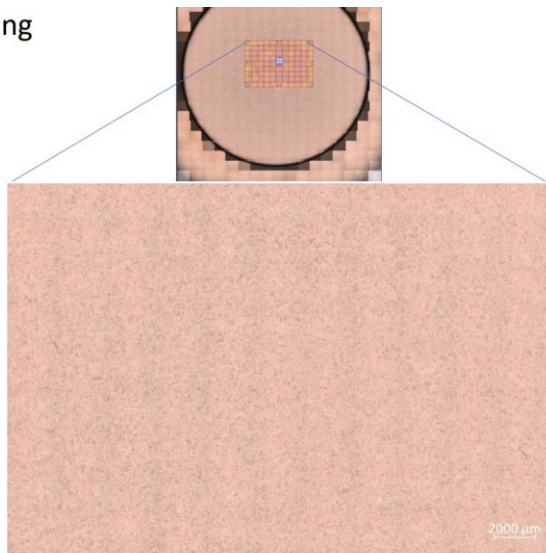
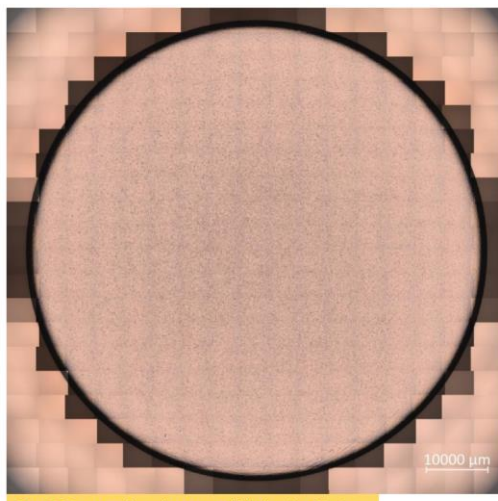


Optimized electropolished Cu QPR sample:

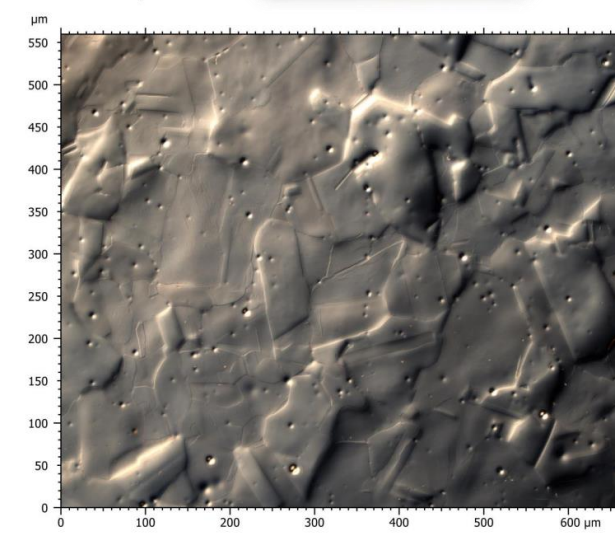
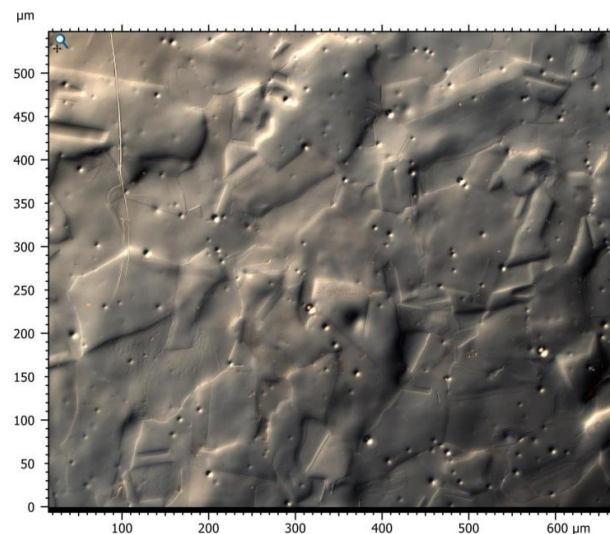
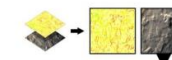
*Alena Prudnikava*



General View: homogeneous polishing



Optical (Polarized Light) Images

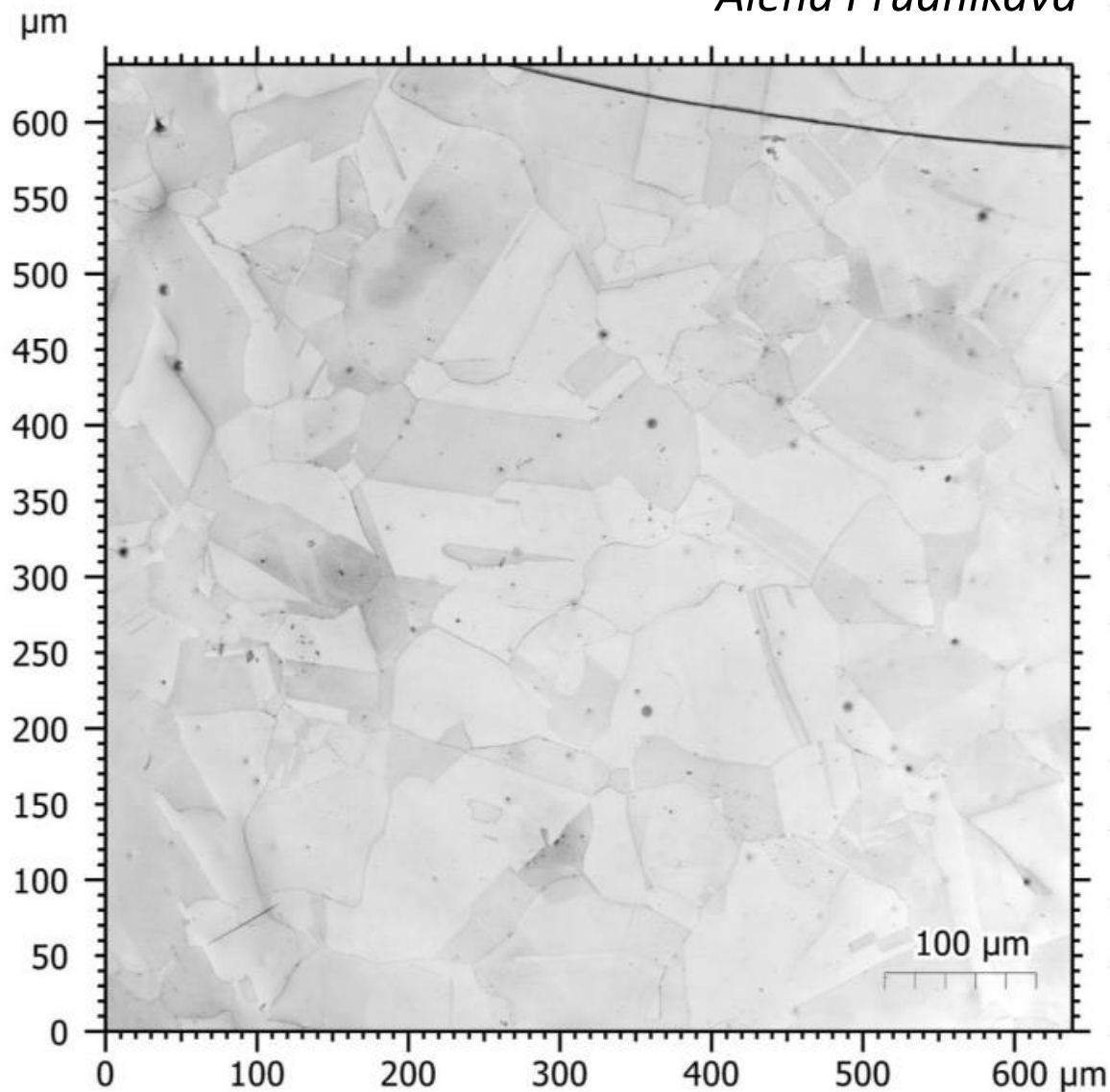


- Observing surface morphology using LSM and measuring surface roughness.
- There are small pitting (1μm) and corrosion on the surface, difficult to completely remove.

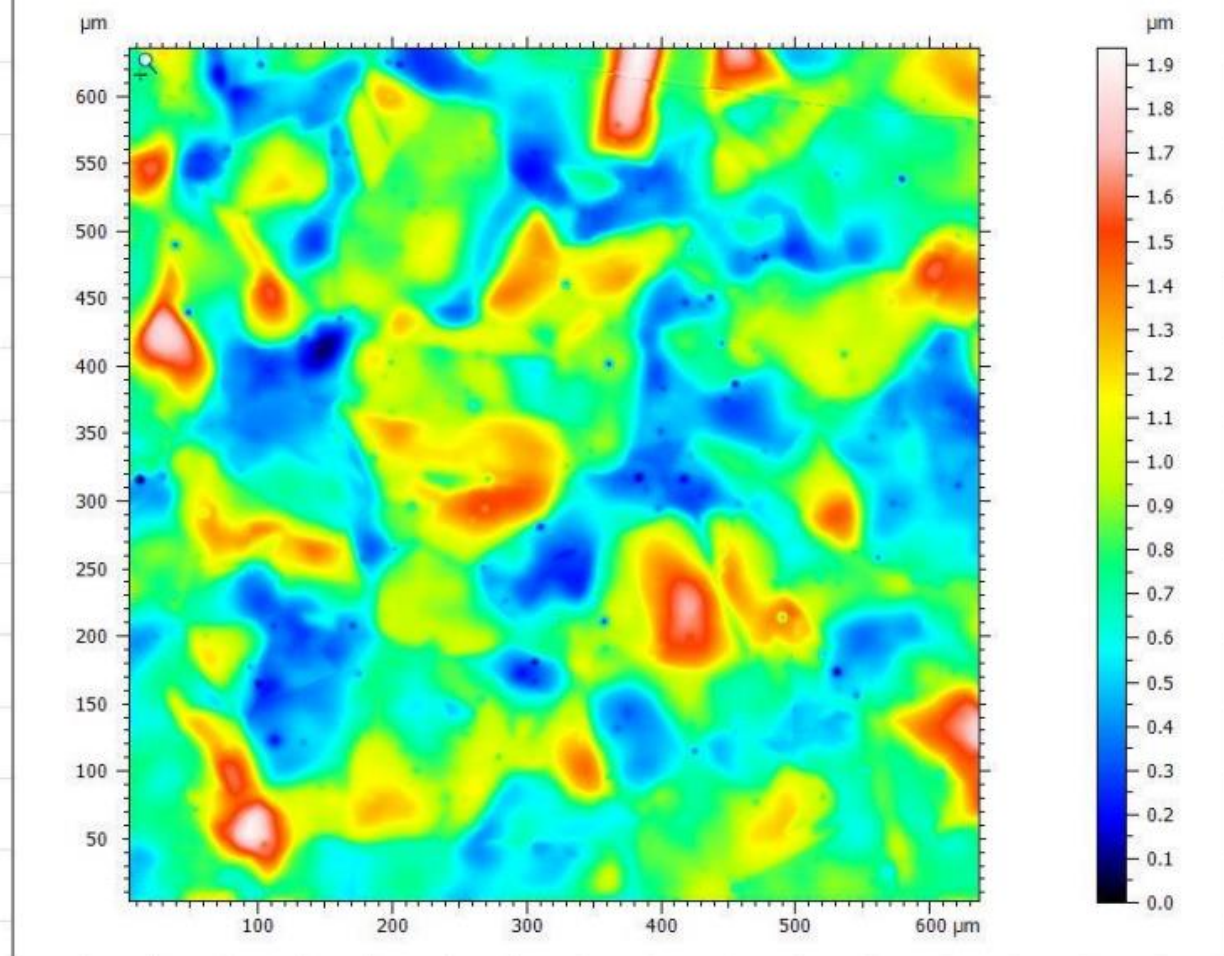


# Surface Roughness

*Alena Prudnikava*



$$S_z = 1.94 \mu\text{m}$$



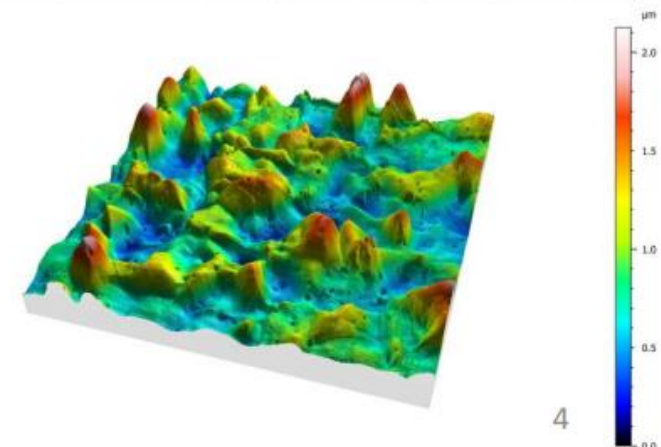
## ISO 25178 - Primary surface

*F:* [Workflow] Form removed (LS-poly 2)

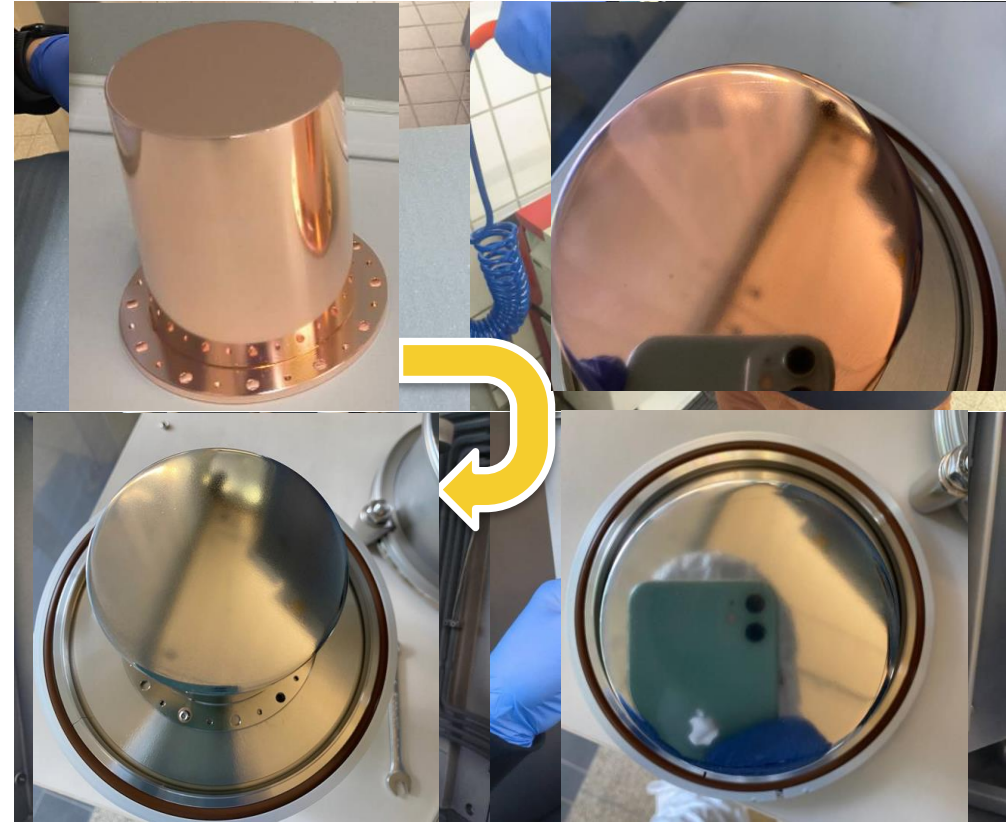
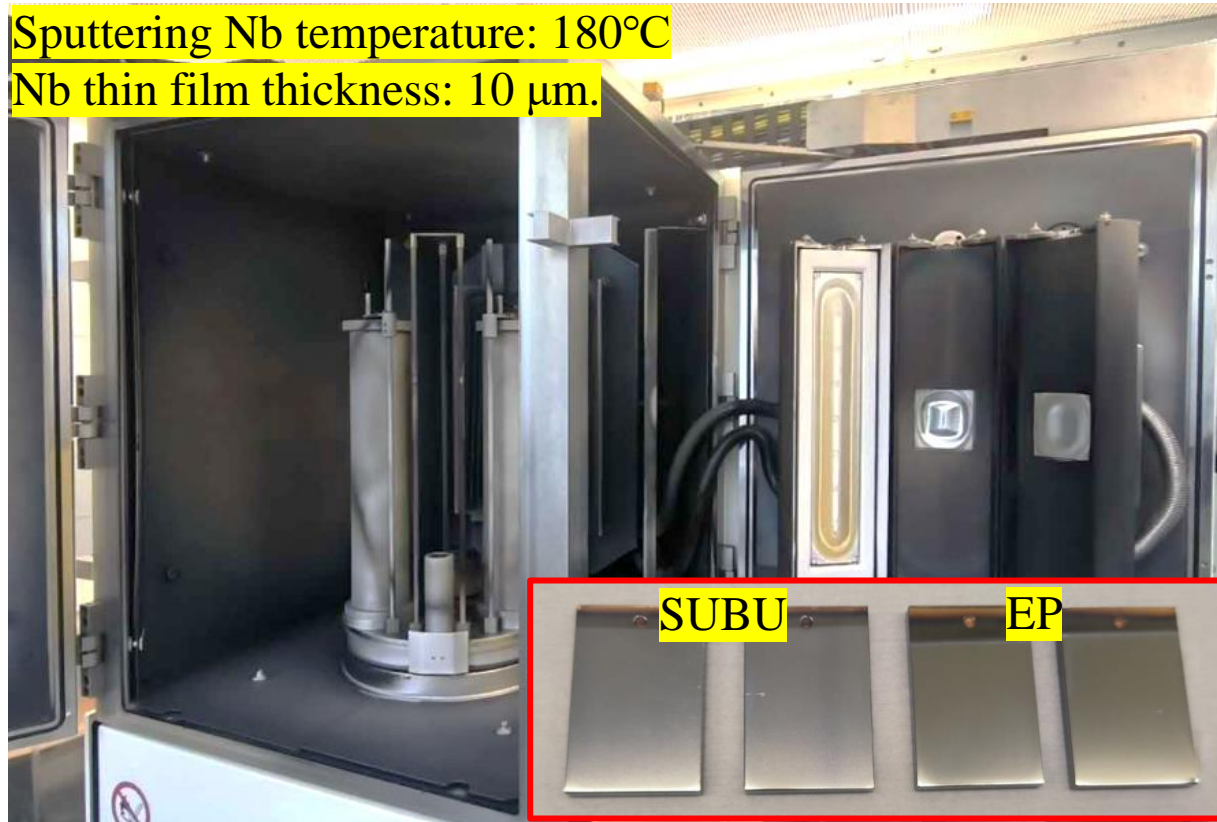
*As Filter:* [Workflow] As-filtered (As 2.500  $\mu\text{m}$ )

### Height parameters

Sq	0.2881 $\mu\text{m}$
Ssk	0.6972
Sku	3.504
Sp	1.145 $\mu\text{m}$
Sv	0.7937 $\mu\text{m}$
Sz	1.938 $\mu\text{m}$
Sa	0.2259 $\mu\text{m}$



Sputtering Nb temperature: 180°C  
 Nb thin film thickness: 10 μm.



*Dr. Aleksandr Zubtsovskii*

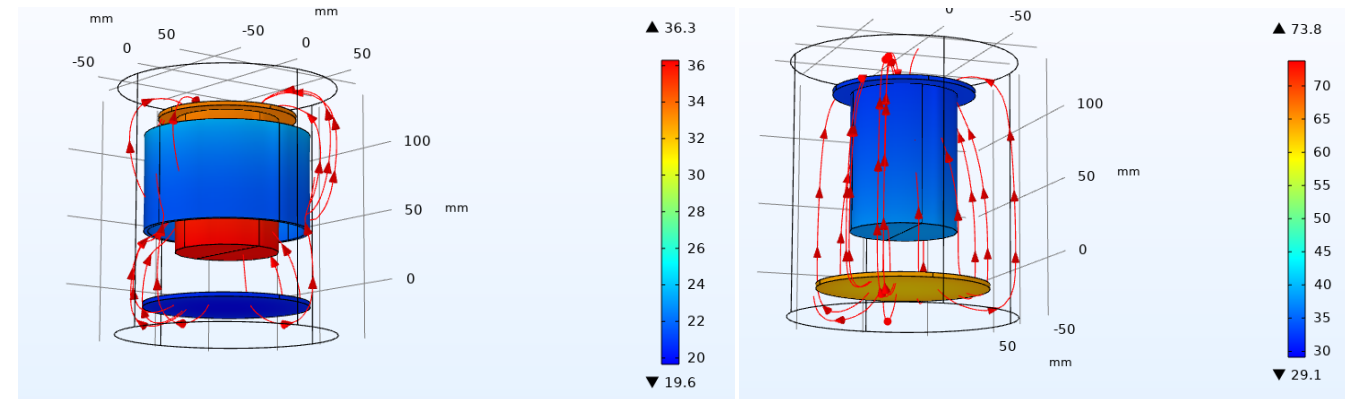
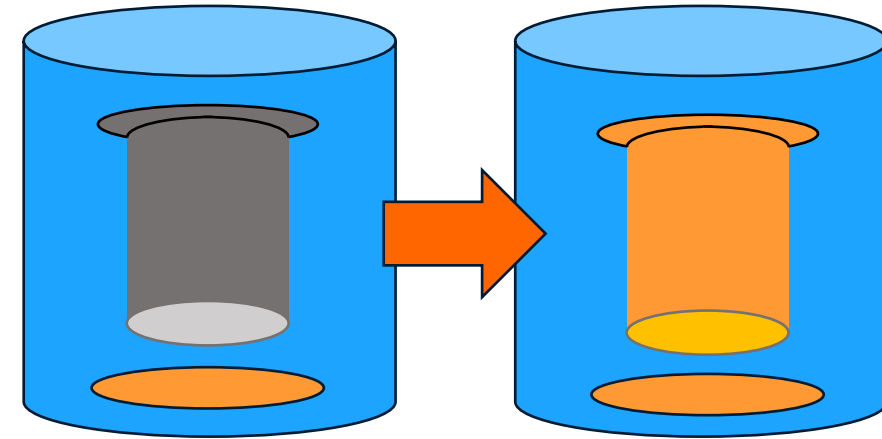
- Cu QPR samples were sputtered with Nb thin films about 10 μm using HiPIMS at Siegen.
- The sputtering temperature is about 180°C, so annealing is required before bronze plating to eliminate thermal expansion mismatch problem.



Optimized anode structure and key parameters:

- **Anode structure:**
  1. QPR samples are placed upside down to reduce the deposition of impurities from the anode
  2. Only disk anode
- **COMSOL simulation:**

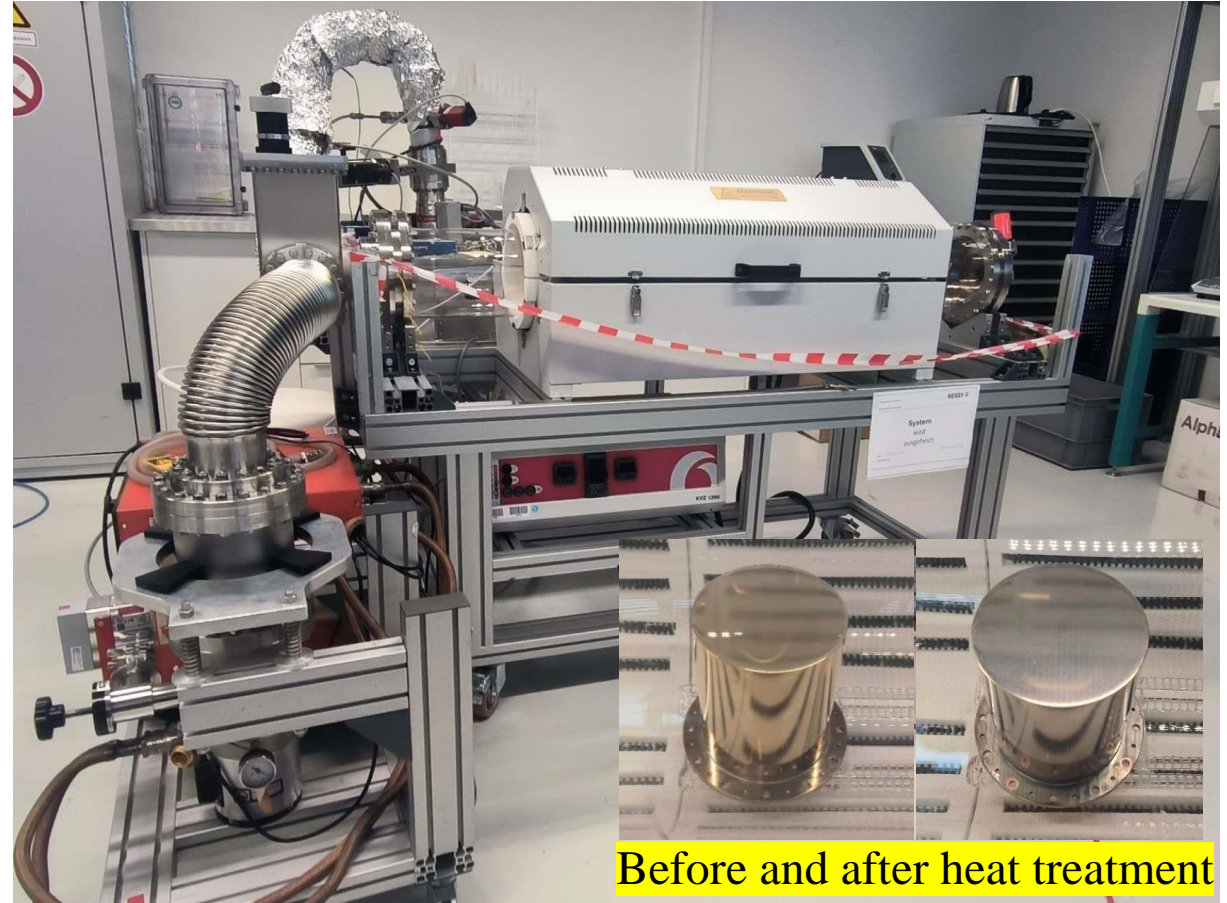
The difference in current density: 1-2 times  
Range: 3-4 mA/cm<sup>2</sup>
- **Parameters:**
  1. CC mode: 0.3 A
  2. Electrode distance: 50 mm
  3. Temperature: 15 °C
  4. Stirring speed: 100 rpm
  5. Electroplating time: 2 h (10 μm)

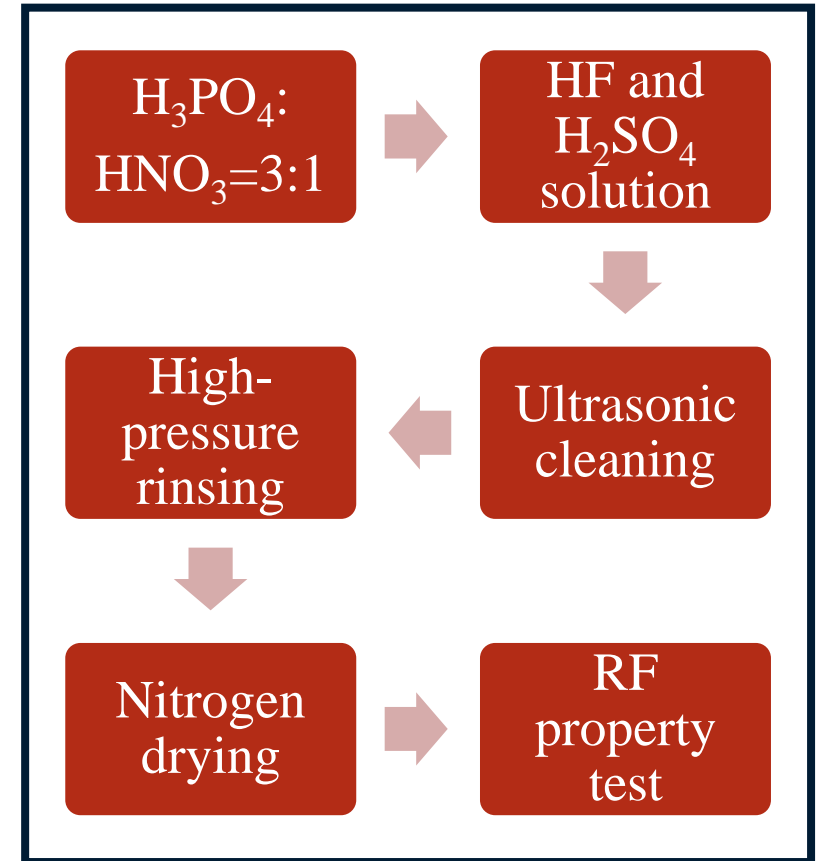




Optimized furnace structure and vacuum pressure:

- **Specific process:**
  1. Placed vertically in a vacuum tube annealing furnace.
  2. QPR samples are placed vertically with glass sample holders at the bottom.
- **Parameters:**
  1. Heat treatment curve:  
600°C(30h)+700°C(30h).
  2. Heating and cooling rates:  
0.5°C/min and 9°C/min .
  3. Vacuum pressure:  
5E-9mbar (room temperature)  
6E-8mbar (at 700°C)





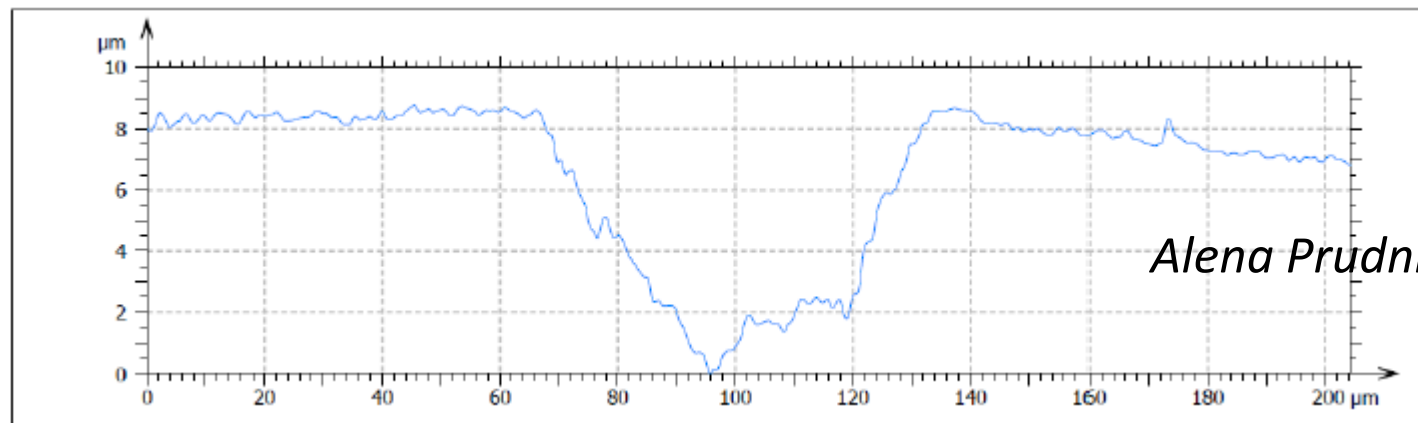
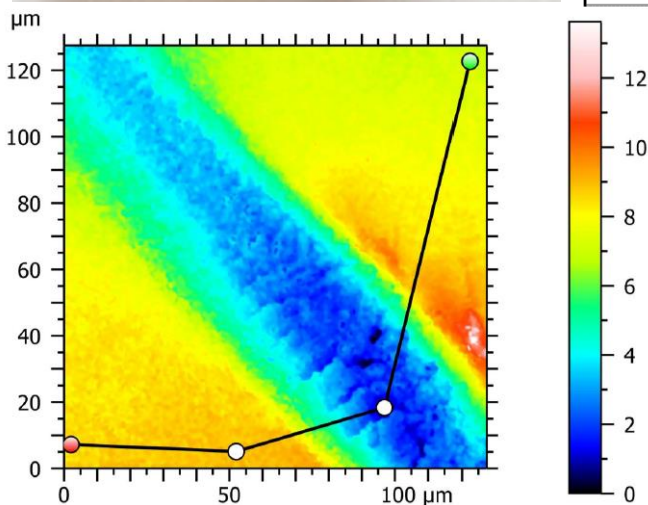
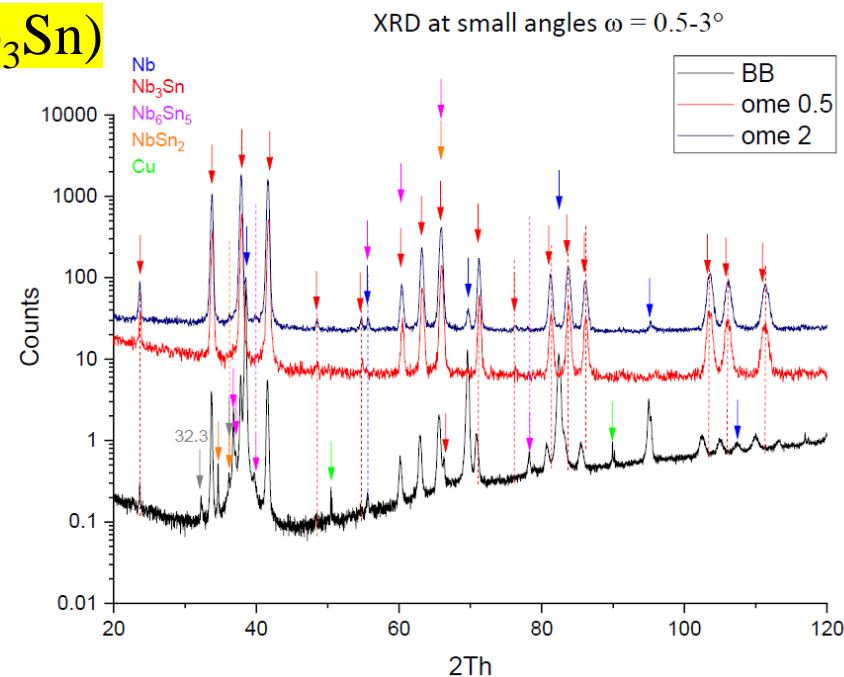
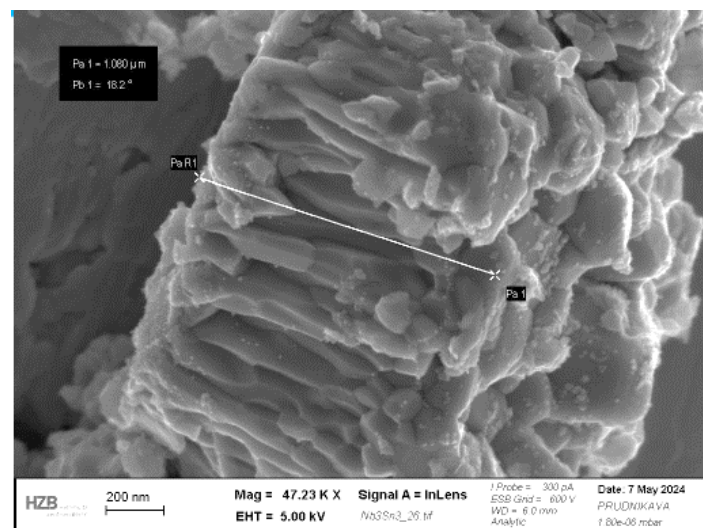
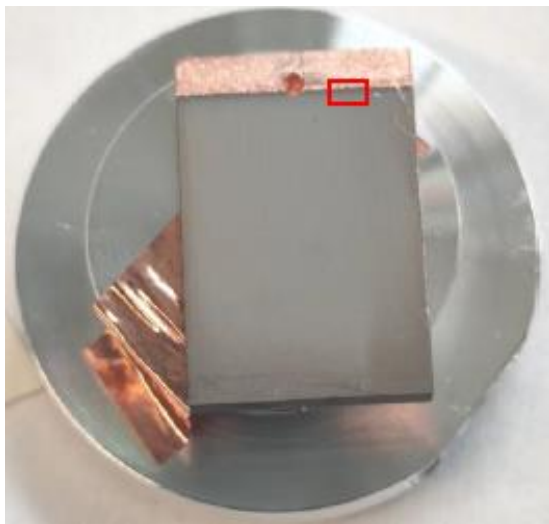
- The thickness of the Nb film at the bottom of the QPR sample is too thin, causing the Nb<sub>3</sub>Sn film to fall off after polishing, exposing the Cu substrate.
- By removing impurities such as bronze, niobium oxide, and carbide on the surface, we obtained a clean Nb<sub>3</sub>Sn/Cu QPR sample.





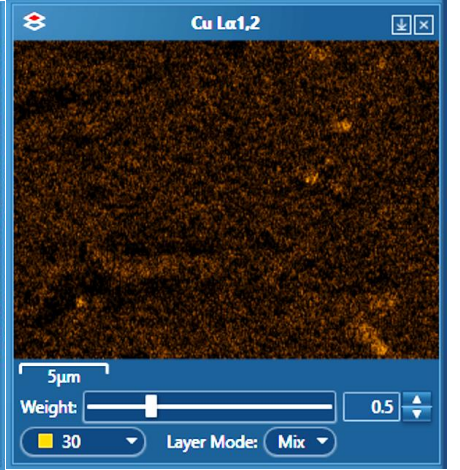
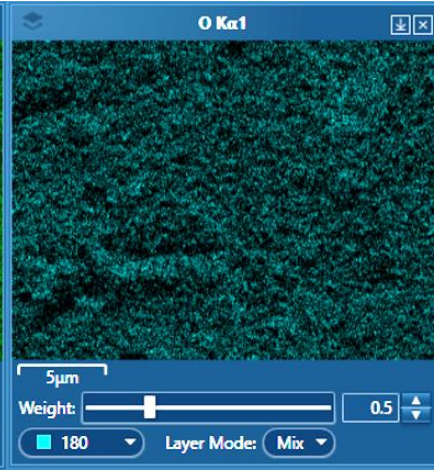
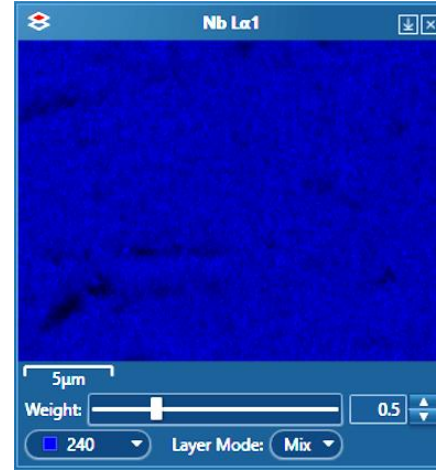
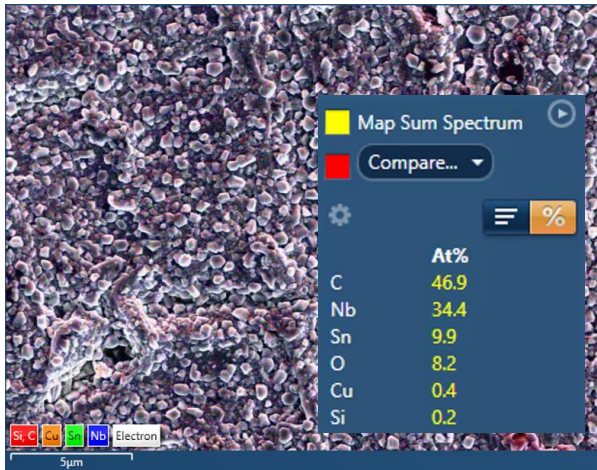
- I have prepared 6 small Nb<sub>3</sub>Sn/Cu samples using the same process and characterized the Nb<sub>3</sub>Sn coatings by LSM, SEM, EDX, XRD, PPMS, etc.

Zeiss LSM: total film thickness 9 μm (8 μm Nb+1 μm Nb<sub>3</sub>Sn)

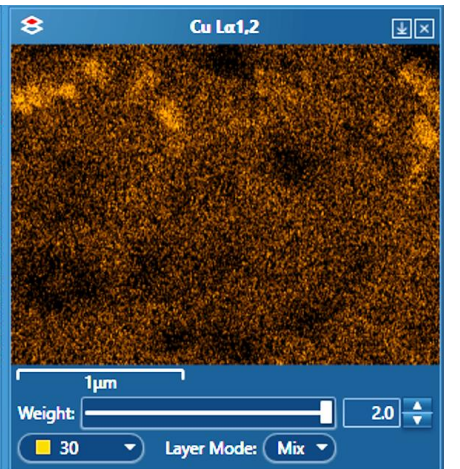
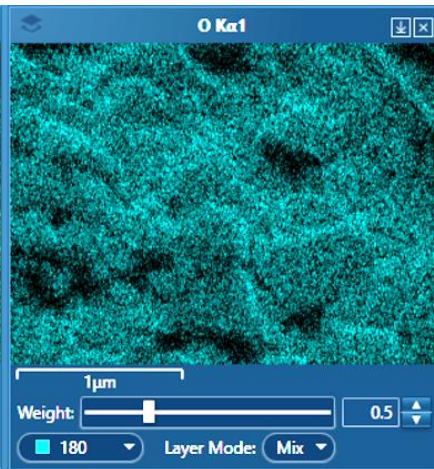
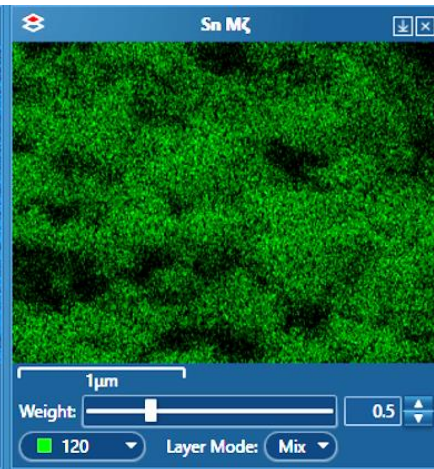
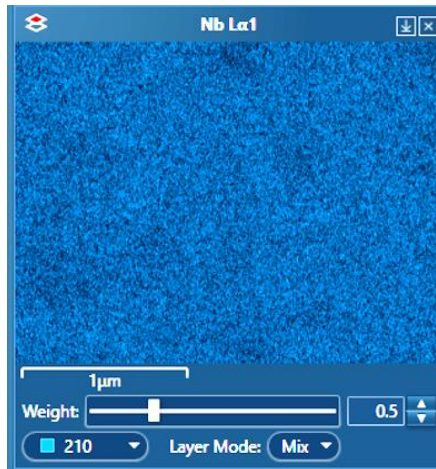
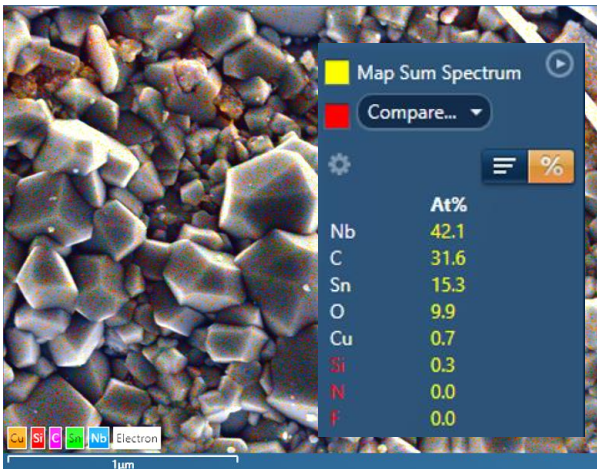




SEM and EDS: Nb<sub>3</sub>Sn surface Sn content 22.35 at%, contains oxides and rare copper impurities.

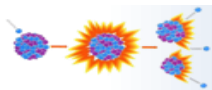


*Alena Prudnikava*





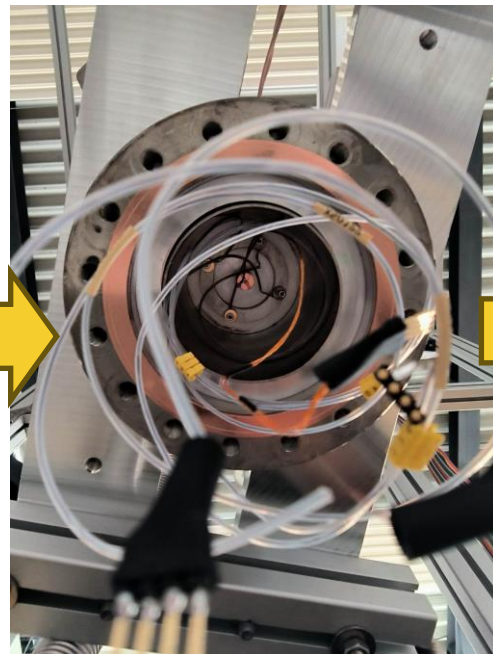
1. Nb<sub>3</sub>Sn and QPR background
2. Overall ETS bronze route progress
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- 4. Nb/Cu QPR sample baseline RF test**
5. Future work and conclusion



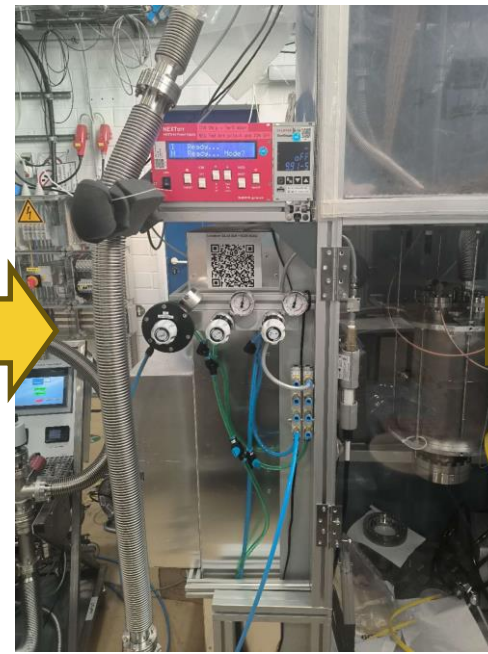
Mount QPR sample



Mount sensor and heater



Check vacuum pressure



Move QPR to cryostat

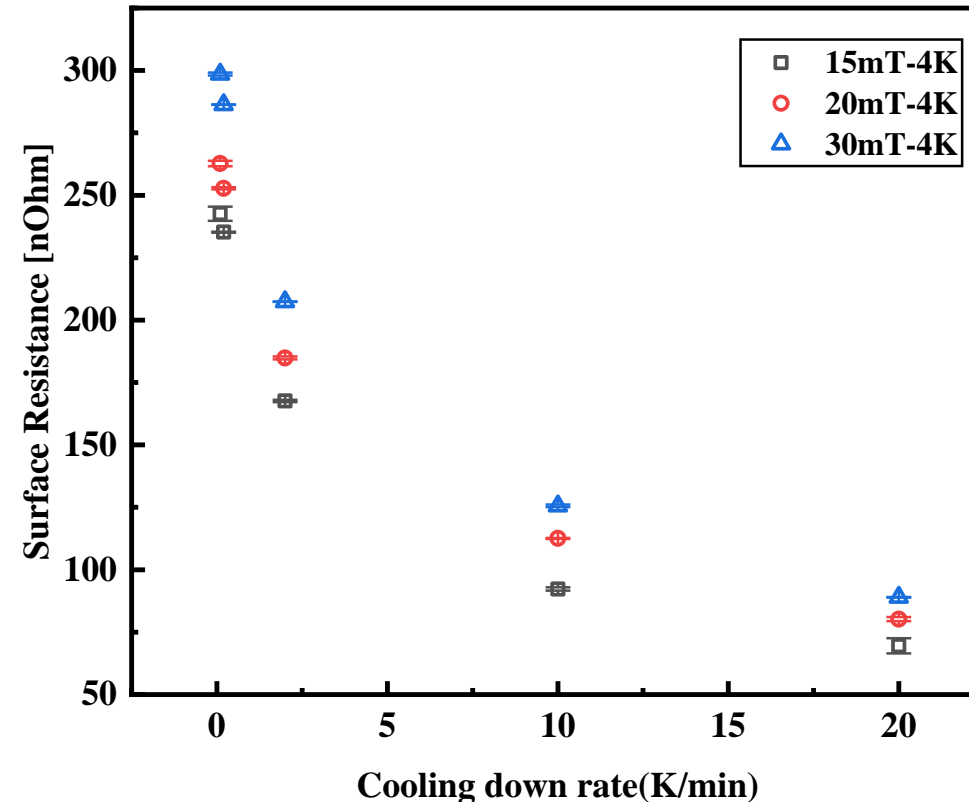
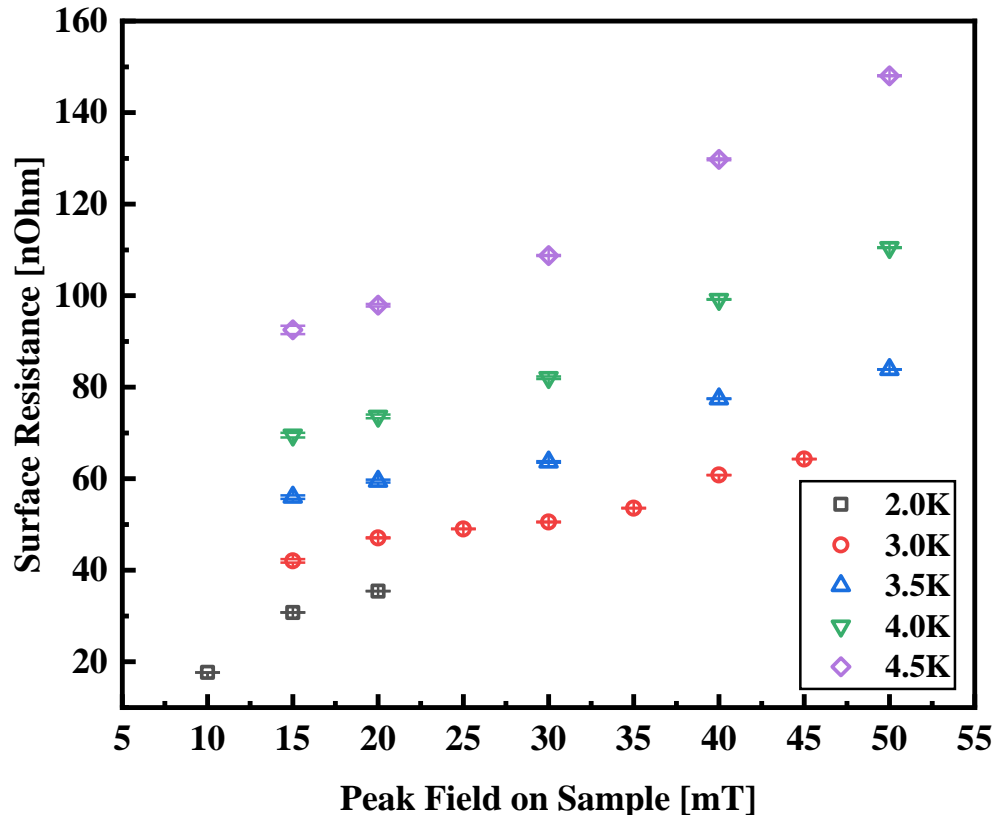


- The Nb/Cu QPR sample is not sealed with indium wire, but only connected with bolts, resulting in poor vacuum (resonator chamber:  $7\text{E}-6$  mbar, thermometry chamber:  $2\text{E}-5$  mbar).
- Control the gap distance by selecting the flange with the appropriate height and vector network analyzer test. (a total of 7 flanges with different heights)

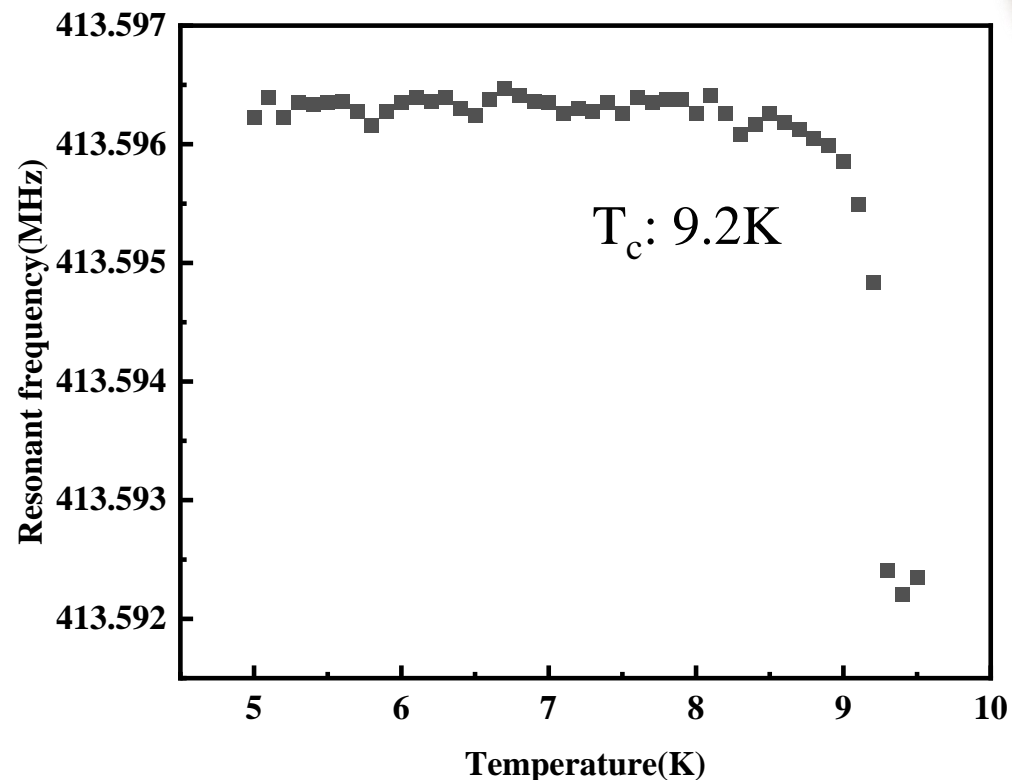
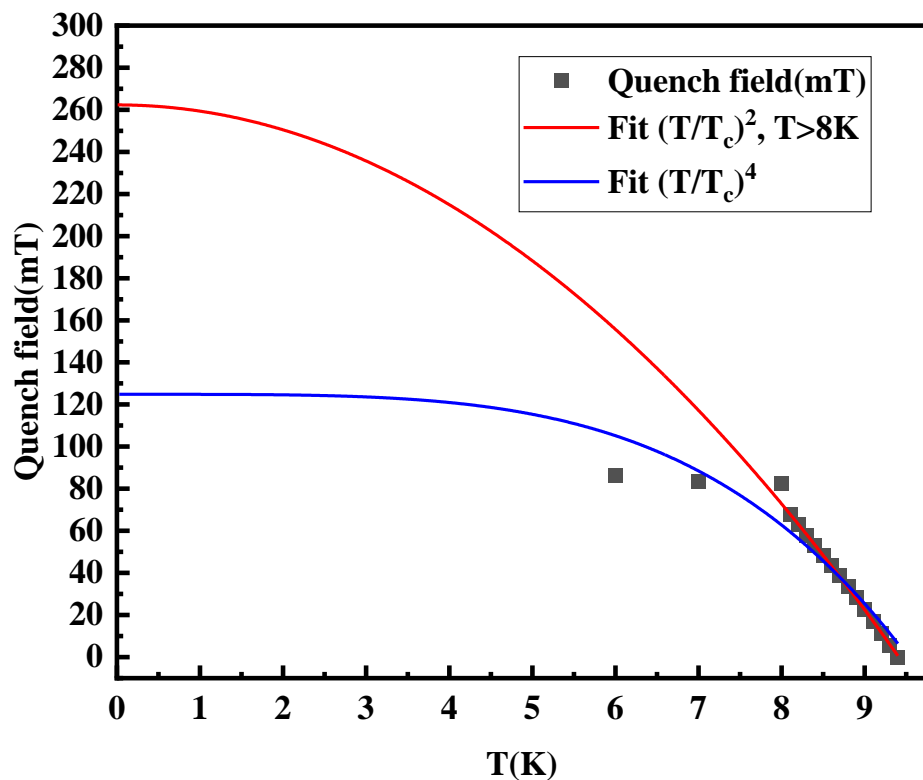
*Sebastian Keckert*



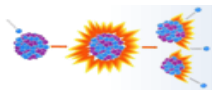
- 413 MHz:  $R_s$  is measured to be about 33 nΩ at 2 K and 15 mT ( $R_{BCS}$  1 nΩ +  $R_{res}$  32 nΩ) .
- The Nb coating quality is average: Severe Q-slope and RF heat limit occur.



- Performed multiple thermal cycles from 10-2K: 120-20 nΩ at 2K and 10mT, 240-60 nΩ at 4K and 15mT.
- Nb/Cu QPR sample: When cooling through the critical temperature, the larger the rate, the less thermal current and less magnetic flux is trapped.



➤ From T- $B_{\text{quench}}$  curve fitting  $(T/T_c)^2$ ,  $T > 8\text{K}$ , we got  $B_{\text{quench}}(0\text{K})$ : 260mT and  $T_c$ : 9.24K (VNA data)



- **Aim:**

Nb<sub>3</sub>Sn/Cu surface impurities optimization. (Cu, Oxides, Carbides).

Nb<sub>3</sub>Sn/Cu RF loss analysis and loss mechanism study.

Nb<sub>3</sub>Sn coating growth mechanism study and grain control.

- **Next:**

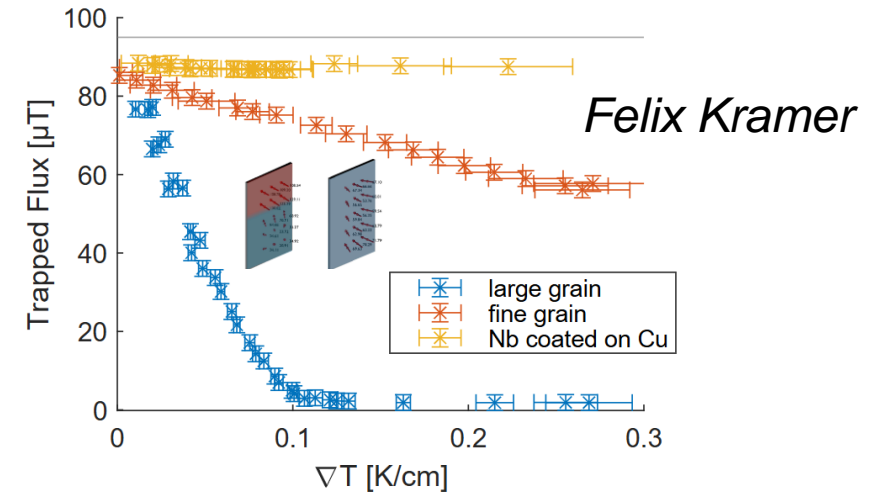
Nb<sub>3</sub>Sn/Cu QPR sample test scheduled in Oct 2024.

Trap flux study of Nb<sub>3</sub>Sn coating on Cu substrate (TraMaFlu).

- **Future:**

Small samples -> larger samples -> QPR samples -> 1.3GHz cavities.

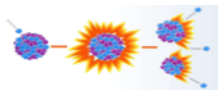
1.3GHz copper cavity Nb sputtering + bronze route Nb<sub>3</sub>Sn coating.



TU Darmstadt (TUD) ?

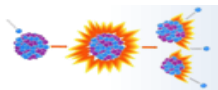


- Cu-based  $\text{Nb}_3\text{Sn}$  combines the excellent thermal conductivity of copper and the superior superconducting properties of  $\text{Nb}_3\text{Sn}$  in SRF field.
- The ETS bronze route is one method to achieve  $\text{Nb}_3\text{Sn}$  coating on copper. Its advantages are low cost, simple operation, suitable for complex cavity types and mass production.
- We provide a complete set of QPR sample preparation processes from copper electropolishing, Nb sputtering, electrodeposition and heat treatment to synthesize  $\text{Nb}_3\text{Sn}$ .
- By optimizing the entire preparation process and key parameters, a new Cu-based  $\text{Nb}_3\text{Sn}$  QPR sample was successfully prepared, and its RF properties will be characterized by QPR testing system at HZB soon.



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- Universität Siegen, Germany  
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**Thanks for your attention.**

